Opti-Cap®
Ultra Broadband DC Blocking

Features
- X7R temperature and voltage stability
- Resonance free DC blocking to >40GHz
- SMT by solder or epoxy bonding
- Low frequency stability over temperature
- Very low series inductance
- 0201, 0402 and 0602 footprints

Functional applications
- Test Equipment, Photonics, SONET, TOSA/ROSA, High Speed Data
- Broadband Microwave/Millimeter Wave
- Transimpedance Amplifiers

Specification
Electrical
Temperature Coefficient of Capacitance
X5R: -55°C to +85°C (TCC ± 15%)
X7R: -55°C to +125°C (TCC ± 15%)
Capacitance Range
1.5nF to 220nF
Maximum Assembly Process Temperature
250°C

Insertion Loss

Electrical characteristics - Opti-Cap®

<table>
<thead>
<tr>
<th>Part Number</th>
<th>Capacitance</th>
<th>Voltage Rating</th>
<th>TCC</th>
<th>DF (Max)</th>
<th>IR (Min)</th>
<th>Frequency Range</th>
</tr>
</thead>
<tbody>
<tr>
<td>P21BN300MA04733</td>
<td>100nF</td>
<td>30pF</td>
<td>10V</td>
<td>3.5%</td>
<td>&gt;10² MΩ</td>
<td>16KHz - &gt;40GHz</td>
</tr>
<tr>
<td>P21BN300MA04282</td>
<td>22nF</td>
<td>30pF</td>
<td>10V</td>
<td>3.5%</td>
<td>&gt;10² MΩ</td>
<td></td>
</tr>
<tr>
<td>P21BN300MA03976</td>
<td>10nF</td>
<td>30pF</td>
<td>10V</td>
<td>3.5%</td>
<td>&gt;10² MΩ</td>
<td></td>
</tr>
<tr>
<td>P21BN300MA04678</td>
<td>1.5nF</td>
<td>30pF</td>
<td>25V</td>
<td>3.5%</td>
<td>&gt;10² MΩ</td>
<td></td>
</tr>
<tr>
<td>P42BN820MA03152</td>
<td>220nF</td>
<td>82pF</td>
<td>10V</td>
<td>3.5%</td>
<td>&gt;10² MΩ</td>
<td></td>
</tr>
<tr>
<td>P42BN820MA04679</td>
<td>22nF</td>
<td>82pF</td>
<td>50V</td>
<td>3.5%</td>
<td>&gt;10² MΩ</td>
<td></td>
</tr>
<tr>
<td>P62BN820MA02636</td>
<td>100nF</td>
<td>82pF</td>
<td>25V</td>
<td>3.5%</td>
<td>&gt;10² MΩ</td>
<td></td>
</tr>
</tbody>
</table>

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### Dimensional specifications - Opti-Cap®

<table>
<thead>
<tr>
<th>Case size</th>
<th>Milli-Cap®</th>
<th>MLC</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td>Length</td>
<td>Width</td>
</tr>
<tr>
<td>P21 (0201)</td>
<td>0.020” ± 0.004”</td>
<td>0.012” ± 0.002”</td>
</tr>
<tr>
<td>P42 (0402)</td>
<td>0.038” ± 0.004”</td>
<td>0.020” ± 0.002”</td>
</tr>
<tr>
<td>P62 (0602)</td>
<td>0.058” ± 0.004”</td>
<td>0.020” ± 0.002”</td>
</tr>
</tbody>
</table>

### Attachment Methods - Opti-Cap®

**Recommended attachment to soft or hard substrate using Conductive Epoxy**
1. Place a single drop of conductive epoxy onto each micro strip as illustrated; the edge of the epoxy shall be at least .003”-.004” back from the edge of the trace to prevent filling the gap with epoxy.
2. Centering the termination gap of the capacitor within the gap in the micro strip, press with careful, even pressure onto the micro strip ensuring the terminations make good contact with the epoxy drops.
3. Cure according to the epoxy manufacturer’s preferred schedule, typically 125°C to 150°C max.
4. After curing, inspect joint for epoxy shorts across the termination and micro strip gaps that would cause a short across the cap.

Isopropanol and Methanol are both safe to use to pre clean Opti-Caps®.

Isopropanol, and Methanol are not to be used after mounting with conductive epoxy as they act as a solvent!

**Recommended attachment to soft or hard substrate using Solder**
1. Place a single drop of solder paste onto each micro strip as illustrated; the edge of the solder shall be at least .001”-.002” back from the edge of the trace to prevent filling the gap with solder.
2. Centering the termination gap of the capacitor within the gap in the micro strip, press with careful, even pressure onto the micro strip ensuring the terminations make good contact with the drops of solder paste.
3. Reflow according to the solder manufacturer’s preferred profile, ensuring the reflow temperature does not exceed 250°C.

4. After the reflow step is completed, inspect joint for voids or excess flux and non-reflowed solder balls that can degrade performance or cause shorts across the gaps. Proper cleaning after the reflow process is crucial to avoiding performance degradation and discovering poor solder joints.

Isopropanol and Methanol are both safe to use with soldered Opti-Caps®.